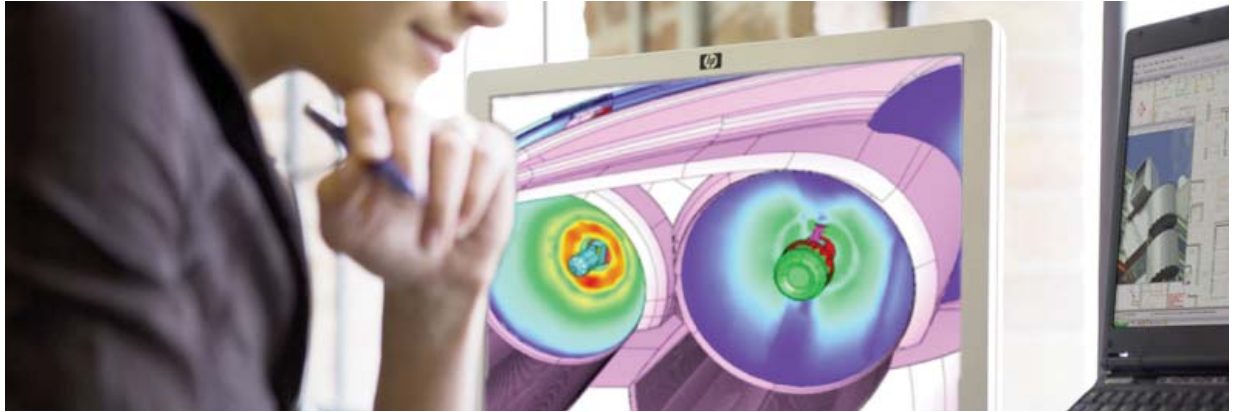


# Join us at the 18th Annual HP CAE Symposium on Technology Trends in Computational Engineering

Tuesday, April 3rd, 2007



Gain valuable technical insight to improve your engineering productivity at our free symposium being held Tuesday, April 3rd, 2007 in Plymouth, MI. Seating is limited—so register today.

#### When:

Tuesday, April 3rd, 2007  
8:30am – 4:00pm

#### Where:

St. John's Inn and Conference Center

44045 Five Mile Road  
Plymouth, Michigan 48170  
Tel 734.414.0600

Hotel information:

<http://www.stjohnsgolfconference.com/home.html>

Note: If you need a hotel room, please reference Group Code HPCATT for the Hewlett-Packard rate of \$139 per night when you contact the hotel. To reserve a hotel room online: [https://reservations.ihotelier.com/crs/g\\_reservation.cfm?groupID=22974&hotelID=6153](https://reservations.ihotelier.com/crs/g_reservation.cfm?groupID=22974&hotelID=6153)

Hewlett-Packard Company and the Allied Engineering cordially invite you to attend the 18th Annual HP CAE Symposium on Tuesday, April 3rd, 2007 at St. John's Inn and Conference Center in Plymouth, MI. This popular one-day symposium brings together 30 of the industry's leading CAE applications experts, HP and industry speakers, and more than 300 engineers and managers to discuss current trends in computer-aided engineering. There is no cost for this event, but seating is limited...so register online today (and no later than March 27, 2007) at [www.hp.com/go/caesympoium](http://www.hp.com/go/caesympoium).

#### Keynote presentations

- Suzy Tichenor, VP & Director of High Performance Computing Initiative, Council on Competitiveness "Out-Compute to Out-Compete: Driving Competitiveness with HPC"
- Lee Fisher, WW CAE Business Manager, Hewlett-Packard Company "Ever Evolving HPC Solutions for CAE"

#### Allied Engineering presentation

Allied Engineering is pleased to be offering the following presentations at the 18th Annual HP CAE Symposium:

- Large Scale Structural Analysis Code ADVC and Its Analysis Examples

#### Seminar tracks

- CAE computing technologies
- Computational fluid dynamics
- Manufacturability/safety
- Pre- and post-processing
- Simulation data management
- Structural analysis

Sponsored by:



Microsoft®

For complete symposium details and agenda, or to register online, visit [www.hp.com/go/caesympoium](http://www.hp.com/go/caesympoium)

© 2007 Hewlett-Packard Development Company, L.P. The information contained herein is subject to change without notice. The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

